

MPAR Symposium II Underpinning for Service Improvements: Technology Innovation and Development—Industry Update

Mike Sarcione Sr. Principal Engineering Fellow mgsarcione@raytheon.com

Norman, OK 18 October 2009

MPAR Challenges Affecting Technology Innovation and Development



- Success requires a balance between <u>performance pull</u> for weather and air traffic surveillance missions and <u>technology push</u> for affordability
 - Capabilities based requirements must avoid pushing the envelope of the technologies,
 e.g. consistent with best commercial manufacturing practices
- n MPAR's <u>performance pull</u> should be affordably architected to meet the needs of the Nation well into the future
 - Provide complete coverage for our borders and CONUS from <1000 to 100K ft.
 in altitude
 - Prioritized needs/capabilities and affordability that plans for modularity, scalability & growth
 - Improves observation missions beyond weather, e.g. natural and induced hazardous phenomena, enables new commercial markets for environmental monitoring and unmanned vehicles, etc.
 - Must meet the needs of a broad customer base well into the future, e.g. proactive on needs for multiple users, quality of service based, timely and accurate
- n MPAR's <u>technology push</u> should leverage high volume best commercial practices and innovation
 - Multiple suppliers, not pushing state-of-the-art component performance, etc.
 - Leverages "green technologies" where possible

Raytheon

Putting MPAR in Perspective by the Numbers

- n 350 MPARs are similar to producing
 - 16,000+ fighter radar apertures
 - 3,300+ SPY-1 radar apertures
- n Requires >250 MW of prime power and produces nearly the same amount of waste heat



Architectures, Technologies and MPAR

- n An affordable architecture
 - Leverages mature technologies/manufacturing processes and innovations of today via good engineering design/implementation
 - Minimizes inventions, yet evolves with the technologies and innovations of tomorrow
- Most, if not all of the technologies, HW and SW exist, many in the commercial base that would enable an affordable and capable architecture
- Defense and commercial industries provide much technology leverage
 - Lower cost silicon for most if not all the electronics, including RF devices/circuits
 - Existing technologies in networking, multi-level security, data management/distribution, resource management technologies have all been demonstrated in similar commercial and/or defense applications

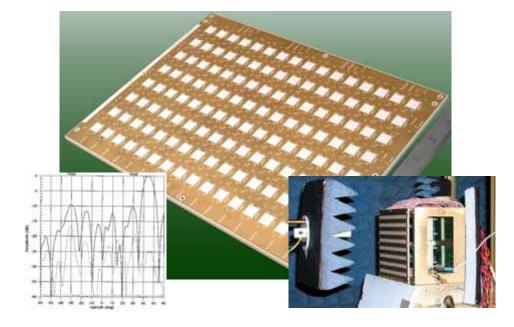


A Few Key Enabling Technology Trends

- n Commercial GaAs, RFCMOS and Silicon Germanium
- n Surface mount electronics, plastic package electronics
- n Modular and open HW and SW architectures, standards
- n Sensor netting and multi-statics, multi-spectral
- Digital beamforming/waveform generation and signal/data processing
- n Knowledge/resource management, information assurance

What's Raytheon Doing to Enable MPAR?

- n Demonstrated an X-band air cooled Array Panel build much like a "Computer-Board"
 - Significant reduction in fabrication/ assembly steps and components
 - No leading edge technology
 - Built in a commercial factory
 - Concept is applicable to any microwave frequency



- Demonstrated sensor netting/fusion, resource & track management products
- n Industry partner for the NSF Collaborative and Adaptive Sensing of the Atmosphere (CASA) Program



